# 5-800 MHz Internally Matched IF Amplifier



#### **Device Features**

- OIP3 = 43.0 dBm @ 70 MHz
- Gain = 17.5 dB @ 70 MHz
- Output P1 dB = 20.5 dBm @ 70 MHz
- 50 Ω Cascadable
- Patented temperature compensation
- Patented over voltage protection
- Lead-free/RoHS-compliant SOT-89 SMT package



Typical Performance<sup>1</sup>

Parameter		F	requency			Unit
	70	140	250	500	800	MHz
Gain	17.5	17.5	17.5	17.5	17.1	dB
S11	-15.8	-15.4	-15.5	-14.1	-18.3	dB
S22	-17.1	-19.1	-26.3	-16.1	-10.8	dB
OIP3 <sup>2</sup>	43.0	42.5	41.0	40.0	37.0	dBm
P1dB	20.5	20.5	20.5	21.0	21.0	dBm
Noise Figure	4.0	4.1	4.2	4.3	4.3	dB

<sup>&</sup>lt;sup>1</sup> Device performance \_ measured on a BeRex evaluation board at 25°C, 50 Ω system.

 $<sup>^{2}\,</sup>$  OIP3  $\_$  measured with two tones at an output of 10 dBm per tone separated by 1 MHz.

	Min.	Typical	Max.	Unit
Bandwidth	5		800	MHz
I <sub>c</sub> @ (Vc = 5V)	97	107	117	mA
V <sub>C</sub>		5.0		V
dG/dT		-0.003		dB/°C
R <sub>TH</sub>		50		°C/W

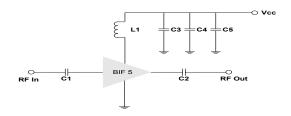
### **Product Description**

BeRex's BIF5 is a high performance InGaP/GaAs HBT MMIC amplifier, internally matched to 50 Ohms and uses a patented *temperature compensation* circuit to provide stable current over the operating temperature range without the need for external components and a patented *over voltage protection* circuit to protect a internal device. The BIF5 is designed for high linearity IF amplifier that requires excellent gain, high OIP3 and flatness. It is packaged in a ROHS-compliant with SOT-89 surface mount package.

#### **Applications**

- Base station Infrastructure/RFID
- Commercial/Industrial/Military wireless system

### **Applications Circuit**



<sup>\*</sup>C1, C2=100nF ± 5%; C3 = 100 pF ± 5%; C4 = 1000pF ±5%

#### **Absolute Maximum Ratings**

Parameter	Rating	Unit
Operating Case Temperature	-40 to +85	°C
Storage Temperature	-55 to +155	°C
Junction Temperature	+220	°C
Operating Voltage	+6.0	V
Supply Current	160	mA
Input RF Power	23	dBm

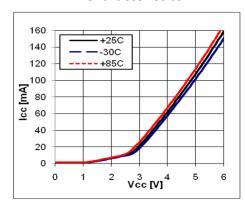
 $Operation \ of \ this \ device \ above \ any \ of \ these \ parameters \ may \ result \ in \ permanent \ damage.$ 

<sup>\*</sup>C5 = 10uF; L1 = 1uH ±5%

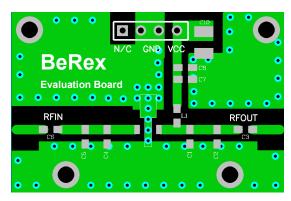
<sup>\*</sup>C1, C2 = 100pF; L1 = 33nH  $\pm$ 5% for RF Bandwidth



#### **V-I Characteristics**



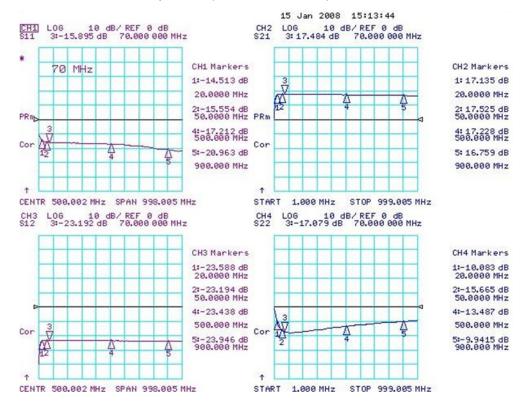
#### **BeRex SOT89 Evaluation Board**



\*Dielectric constant \_ 4.2 \*RF pattern width 52mil \*31mil thick FR4 PCB

## **Typical Device Data**

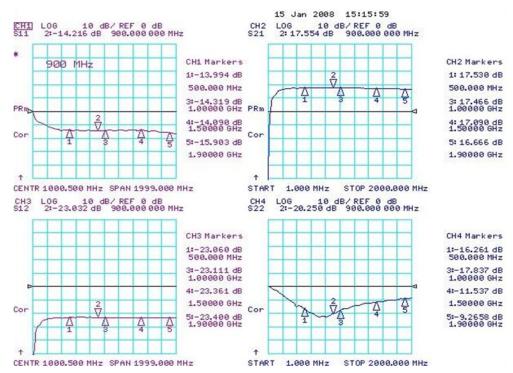
S-parameters (Vc=5V, Ic=107mA, T=25°C)





### **RF Bandwidth**

S-parameters (Vc=5V, Ic=107mA, T=25°C)





### **S-Parameter**

(Vdevice = 5.0V, Icc = 107mA, T = 25 °C, calibrated to device leads)

Freq [MHz]	S11 [Mag]	S11 [Ang]	S21 [Mag]	S21 [Ang]	S12 [Mag]	S12 [Ang]	S22 [Mag]	S22 [Ang]
100	0.635	175.5	8.232	175.6	0.066	0.3	0.155	-12.0
500	0.627	157.0	7.315	159.7	0.072	-1.4	0.178	-62.9
1000	0.603	136.7	7.880	144.7	0.066	-1.8	0.235	-111.5
1500	0.580	118.0	6.733	131.1	0.070	2.4	0.322	-151.7
2000	0.491	99.4	6.895	114.4	0.069	-1.7	0.393	175.7
2500	0.471	86.3	6.953	104.4	0.071	5.1	0.470	147.9
3000	0.432	69.7	8.427	80.7	0.080	-0.9	0.549	119.3
3500	0.415	63.8	7.474	53.8	0.079	-0.9	0.608	97.8
4000	0.457	51.4	6.617	32.7	0.090	-8.8	0.640	68.7

Typical Performance (Vd = 5V, Ic = 107mA, T = 25°C)

Freq	MHz	70	140	250	*500	800
S21	dB	17.5	17.5	17.5	17.5	17.1
S11	dB	-15.8	-15.4	-15.5	-14.1	-18.3
S22	dB	-17.1	-19.1	-26.3	-16.1	-10.8
P1	dBm	20.5	20.5	20.5	21.0	21
OIP3	dBm	43	42.5	41.0	40.0	37
NF	dB	4.0	4.1	4.2	4.3	4.3

Typical Performance (Vd = 4.7V, Ic = 95mA, T = 25°C)

Freq	MHz	70	140	250	500	800
S21	dB	17.6	17.5	17.4	17.4	17.1
S11	dB	-15.1	-17.3	-18.1	-17.5	-18.7
S22	dB	-14.3	-13.7	-14.1	-14	-10.7
P1	dBm	19.6	20.2	20.1	20.4	20
OIP3	dBm	41	40.5	39.5	37	35.5
NF	dB	4.0	4.1	4.2	4.3	4.3

Typical Performance (Vd = 4.5V, Ic = 85mA, T = 25°C)

Freq	MHz	70	140	250	500	800
S21	dB	17.4	17.4	17.5	17.4	17
S11	dB	-15.3	-17.6	-18.3	-17.8	-18.9
S22	dB	-14.2	-13.5	-13.9	-13.9	-10.6
P1	dBm	19.2	19.0	19.2	19.4	19.4
OIP3	dBm	40.0	41.0	38.5	36.5	35
NF	dB	4.0	4.1	4.2	4.3	4.3

BeRex

• website: <u>www.berex.com</u>

• email: sales@berex.com

# 5-800 MHz Internally Matched IF Amplifier



### Typical Performance (Vd = 4V, Ic = 63mA, T = 25°C)

Freq	MHz	70	140	250	500	800
S21	dB	17.4	17.3	17.2	17.2	16.9
S11	dB	-16	-18.6	-19.5	-18.9	-20.1
S22	dB	-13.8	-13.1	-13.5	-13.5	-10.3
P1	dBm	17	17.5	17.7	17.5	17.2
OIP3	dBm	35.5	35.5	35	33	32
NF	dB	4.0	4.1	4.2	4.3	4.3

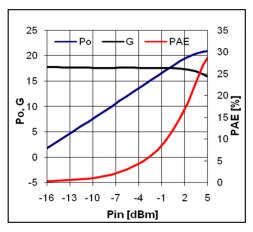
### Typical Performance (Vd = 3.5V, Ic = 41mA, T = 25°C)

	•		•			
Freq	MHz	70	140	250	500	800
S21	dB	17.1	17.0	16.9	16.8	16.5
S11	dB	-17.9	-21.2	-22.6	-21.7	-23.1
S22	dB	-13.1	-12.3	-12.6	-12.6	-9.8
P1	dBm	13.7	14.6	14.6	14.5	14.2
OIP3	dBm	29	29	29	27.5	27.5
NF	dB	4.0	4.1	4.2	4.3	4.3

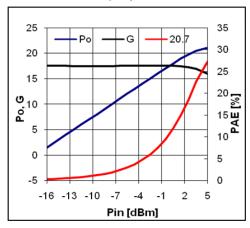


### **Device Performance**

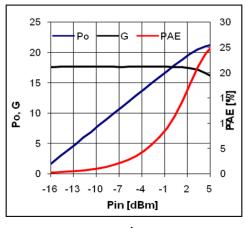
### **Pin-Pout-Gain**



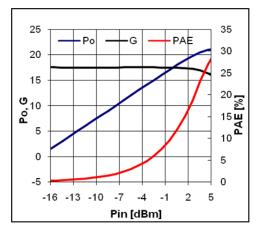
#### 70MHz, 5V/107mA



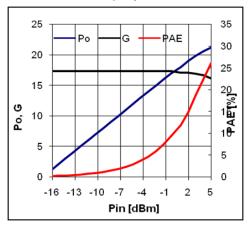
#### 250MHz, 5V/107mA



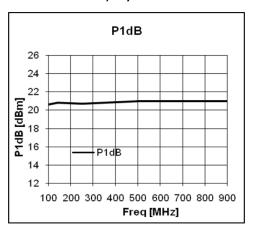
### 900MHz, 5V/107mA



### 140MHz, 5V/107mA



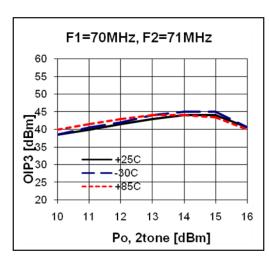
#### 500MHz, 5V/107mA

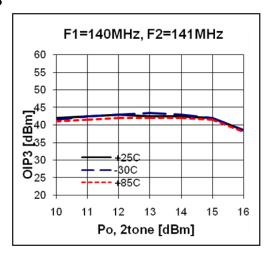


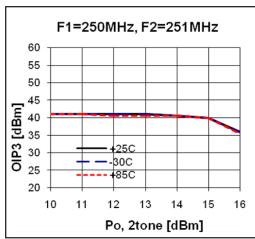
# 5-800 MHz Internally Matched IF Amplifier

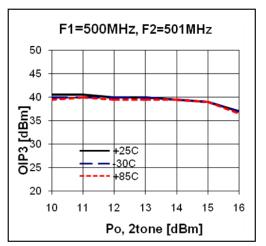


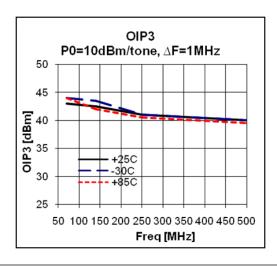
### OIP3







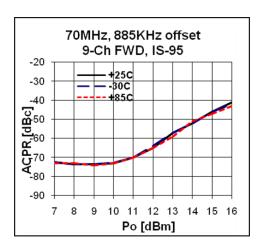


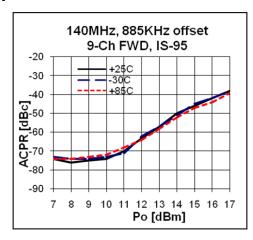


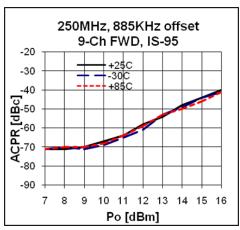
# 5-800 MHz Internally Matched IF Amplifier

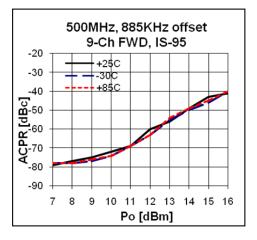


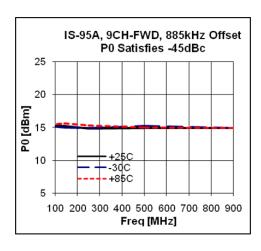
### **ACPR**





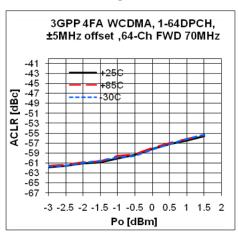




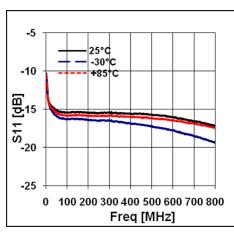


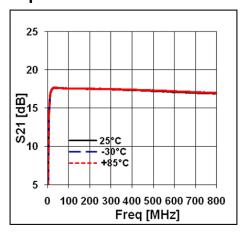


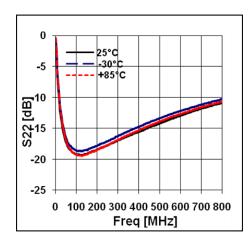
### **ACLR**

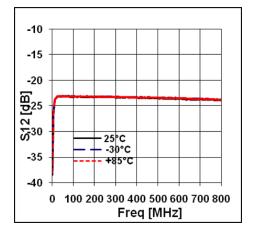


# **S-Parameters over Temperature**



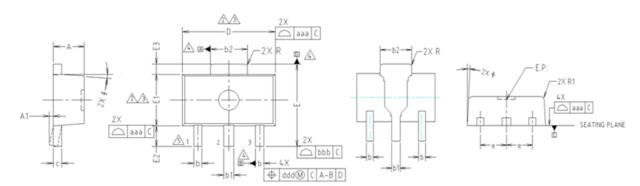








## **Package Outline Dimension**



NOTE:

1. DIMENSIONS IN MILLIMETERS.

DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 8.5mm PER END.

DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.

INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 8.5mm PER SIDE.

☑ DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

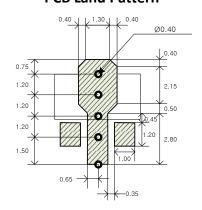
A DATUMS A, B AND D TO BE DETERMINED 8.18mm FROM THE LEAD TIP.

TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

		MILLI	METERS	S	NOTE
SYMBOL	MINIMUM	NON	JINAL	MAXIMUM	NOTE
A	1.40	1	.50	1.60	
A1	0.00		_	0.10	
Ь	0.38	(	).42	0.48	
ь1	0.48	0	.52	0.58	
b2	1.79	1	.82	1.87	
C	0.40	0	.42	0.46	
D	4.40	4	.50	4.70	2,3
Ε	3.70	4	.00	4.30	
E E1	2.40	2	.50	2.70	2,3
E2	0.80	1	.00	1.20	
E3	0.40	0	.50	0.60	
e		1.5	O TYP.		
0			TYP.		
R		0.1	5 TYP.		
R1	-		_	0.20	
SYMBOL	TOLERANCES OF AND POSI	FORM	NOTE		
aaa	0.15				
bbb	0.20				
ccc	0.10				
ddd	0.10			1	

## **Suggested PCB Land Pattern and PAD Layout**

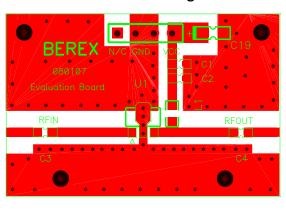
### **PCB Land Pattern**



Note : All dimension \_ millimeters

PCB lay out \_ on BeRex website

### **PCB Mounting**



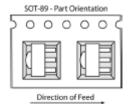
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## Tape & Reel

#### **SOT89**

Packaging information:



Tape Width (mm): 12 Reel Size (inches): 7

Device Cavity Pitch (mm): 8

Devices Per Reel: 1000

# **Lead plating finish**

#### 100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

# MSL / ESD Rating

**ESD Rating:** Class 1C

Value: Passes <2000V

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114B

MSL Rating: Level 1 at +265°C convection reflow

**Standard:** JEDEC Standard J-STD-020

### **NATO CAGE code:**

2   N   9   6   F
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